

SPECIFICATION FOR APPROVAL

Cı	ıstomer	Name:					
Cı	ıstomer	· Item :					
Pa	ırt No.	: PR-S188HQ-CR14	44B-HDT				
Pr	oduct C	escription :					
Dr	Draw Date:						
1.Accessory: Samples Samples Data 2.Customer's Proposal: Agree Disagree Reason:							
	Rev.	Draw by:	Checked by:	Approved by:			
	1.2.1	Steven Chen	Gray Huang	Caren			
	Customer Approve						



Features

1.6mmx0.8mm SMD LED, 0.55mm thickness

Welding Plate 0.1mm*2

Low power consumption

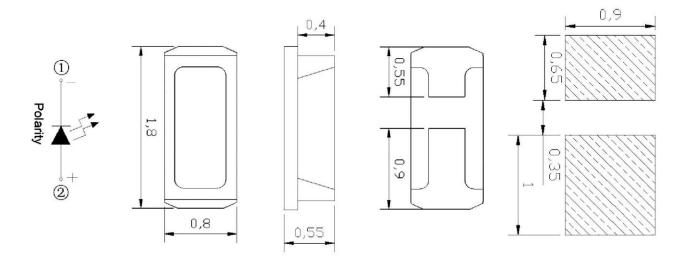
Wide view angle

Package: 4000pcs/reel

RoHS Compliant



Package outlines/ Recommend Pad Layout



Part No.	Emitted color	Dice	Lens color	
PR-S188HQ-CR144B-HDT	Red	AlGaInP	Water transparent	

Notes:

- 1. All dimensions are in millimeters (inches);
- 2. Tolerances are ± 0.1 mm (0.004inch) unless otherwise noted.

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Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Value	Unit
Forward current	If	50	mA
Reverse voltage	Vr	5	V
Power dissipation	Pd	100	mW
Operating temperature	Тор	-40 ~+85	$^{\circ}$
ESD(Human-body mode)		2	KV
Storage temperature	Tstg	- 40 ∼+85	°C
Peak pulsing current (1/8 duty f=1kHz)	Ifp	120	mA

Electro-Optical Characteristics (Ta=25°C)

Parameter	Test Condition	Symbol	Value			IIn:t
- rarameter			Min	Тур	Max	Unit
Wavelength at peak emission	If=50mA	λр		660		nm
Spectral half bandwidth	If=50mA	Δλ		20		nm
Dominant wavelength	If=50mA	λd				nm
Forward voltage	If=50mA	Vf	1.8	2.2	2.4	V
Luminous intensity	If=50mA	Iv		10		Mw/Sr
Viewing angle at 50% Iv	If=50mA	201/2		120		Deg
Reverse current	Vr=5V	Ir			10	μΑ

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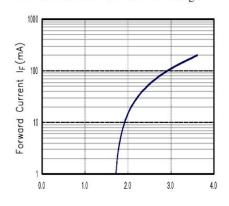
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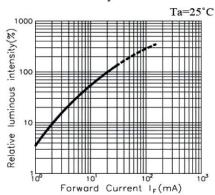
Radiation Characteristics

IF=50mA,Ta=25°C

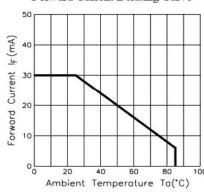
Forward Current Vs. Forward Voltage



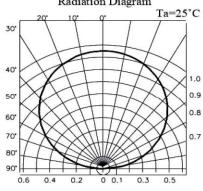
Luminous Intensity Vs. Forward Current



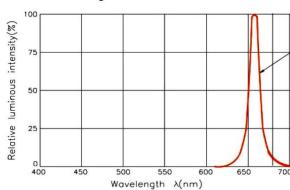
Forward Current Derating Curve



Radiation Diagram



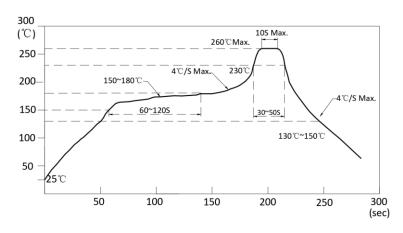
Spectrum Distribution





Reflow Profile

■ Reflow Temp/Time



Notes:

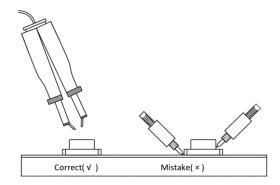
- 1. We recommend the reflow temperature 245° C ($\pm 5^{\circ}$ C).
- 2. The maximum soldering temperature should be limited to 260°C.
- 3. Don't cause stress to the epoxy resin while it is exposed to high temperature.
- 4. Number of reflow process shall be 2 times or less.

■Soldering iron

Basic spec is $\frac{c}{\lambda}$ 5sec when 320°C (±20°C). If temperature is higher, time should be shorter (+10°C \rightarrow -1sec). Power dissipation of iron should be smaller than 20W, and temperatures should be controllable .Surface temperature of the device should be under 350°C.

■Rework

- 1. Customer must finish rework within 5 sec under 340°C.
- 2. The head of iron cannot touch copper foil
- 3. Twin-head type is preferred.



■ Avoid rubbing or scraping the resin by any object, during high temperature, for example reflow solder etc.

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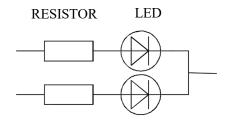
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Handling precautions

1.Drive Method

A LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit below.



2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30°C or less and 60% RH or less.
- 2.3 After the package is opened, the products should be used within a week or they should be keeping to store at ≤ 20 R.H. with zip-lock sealed.

3. Baking

It is recommended to baking before soldering when the pack is unsealed after 72hrs. The Conditions are as followings:

- 3.1 60 ± 3 °C x(12~24hrs) and < 5%RH, taped reel type
- $3.2\ 100\pm3^{\circ}$ C x (45min~1hr), bulk type
- 3.3 130±3°C x (15~30min), bulk type

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Test Items and Results of Reliability

Test Item	Test Conditions	Standard Test Method	Note	Number Of Test
Reflow Soldering	Ta=260±5°C,Time=10±2S	JB/T 10845-2008	3times	0/22
Salt Atmosphere	Ta=35±3°C,PH=6.5 ~ 7.2	GB/T 2423.17-2008	24hrs	0/22
Temperature Cycling	-40±5°C 30±1min ↑→(25°C/5±1min)↓ 100±5°C 30±1min	GB/T 2423.22-2012	100cycles	0/22
Thermal Shock	Ta=-40±5°C ~ 100±5°C, 15±1min dwell	GB/T 2423.22-2012	100cycles	0/22
High Humidity High Temp. Cycling	Ta=30±5°C ~ 65±5°C, 90±5%RH,24hrs/1cycle	GB/T 2423.4-2008	10cycles	0/22
High Humidity High Temp. Storage Life	Ta=85±5°C,ψ(%)=85±5%RH	GB/T 2423.3-2006	1000hrs	0/22
High Temperature Storage Life	Ta=100±5°C,non-operating	GB/T 2423.2-2008	1000hrs	0/22
Low Temperature Storage Life	Ta=-40±5°C,non-operating	GB/T 2423.1-2008	1000hrs	0/22
Life Test	Ta=26±5°C,@20mA, ψ(%)=25%RH ~ 55%RH		1000hrs	0/22
High Humidity High Temp. Operating Life	Ta=85±5°C,@20mA, ψ(%)=85%RH	GB/T 2423.3-2006	500hrs	0/22
Low Temperature Operating Life	Ta=-20±5°C,@20mA	GB/T 2423.1-2008	1000hrs	0/22

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